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## FAIRCHILD

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# NC7ST04 TinyLogic® HST Inverter

#### **General Description**

**Ordering Code:** 

The NC7ST04 is a single high performance CMOS Inverter, with TTL-compatible inputs. Advanced Silicon Gate CMOS fabrication assures high speed and low power circuit operation. ESD protection diodes inherently guard both input and output with respect to the  $V_{CC}$  and GND rails. High gain circuitry offers high noise immunity and reduced sensitivity to input edge rate. The TTL-compatible input facilitates TTL to NMOS/CMOS interfacing. Device performance is similar to MM74HCT but with % the output current drive of HC/HCT.

February 1997 Revised August 2004

# NC7ST04 TinyLogic® HST Inverter

mber         Top Mark           A05B         8S04           A05A         T04           C06A         XX	Package Description 5-Lead SOT23, JEDEC MO-178, 1.6mm 5-Lead SC70, EIAJ SC-88a, 1.25mm Wide 6-Lead MicroPak, 1.0mm Wide Connection Diagra Pin Assignments for NC 1					
A05A T04 C06A XX IEEE/IEC	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide 6-Lead MicroPak, 1.0mm Wide Connection Diagra Pin Assignments for	3k Units on Tape and Ree 5k Units on Tape and Ree <b>MS</b> SC70 and SOT23				
IEEE/IEC	6-Lead MicroPak, 1.0mm Wide Connection Diagra Pin Assignments for NC 1	5k Units on Tape and Ree <b>MS</b> SC70 and SOT23				
IEEE/IEC	Connection Diagra Pin Assignments for	SC70 and SOT23				
1 Y	Pin Assignments for	SC70 and SOT23				
1 Y						
		5 V <sub>CC</sub>				
าร						
		ᡨ				
Description	GND 3	L 4 Y				
	(Top Vie	(Top View) Pad Assignments for MicroPak				
No Connect	Pad Assignments					
)						
$\mathbf{Y} = \overline{\mathbf{A}}$		6 V <sub>CC</sub>				
Output	A 2	5 NC				
Y						
Н	GND 3	4 Y				
L						
•	(Top Thru	View)				
	Input       Output       No Connect $Y = \overline{A}$ Output       Y       H	Input     GND     3       Input     GND     3       Output     (Top Vie       No Connect     Pad Assignments       Y = $\overline{A}$ NC 1       Output     A 2       Y     H       GND 3				

**Features** 

TTL-compatible inputs

■ Space saving SOT23 or SC70 5-lead package

 $\blacksquare$  High Speed; t<sub>PD</sub> <7 ns typ, V<sub>CC</sub> = 5V, C<sub>L</sub> = 15 pF

E Low Quiescent Power; I<sub>CC</sub> <1  $\mu$ A typ, V<sub>CC</sub> = 5.5V

 $\blacksquare$  Balanced Output Drive; 2 mA I<sub>OL</sub>, –2 mA I<sub>OH</sub>

■ Ultra small MicroPak<sup>™</sup> leadless package

### Absolute Maximum Ratings(Note 1)

Supply Voltage (V <sub>CC</sub> )	-0.5V to +7.0V	Condi
DC Input Diode Current (I <sub>IK</sub> )		Supply V
$V_{IN} < -0.5V$	–20 mA	Input Vol
$V_{IN} \ge V_{CC} + 0.5V$	+20 mA	Output V
DC Input Voltage (V <sub>IN</sub> )	–0.5V to V <sub>CC</sub> +0.5V	Operatin
DC Output Diode Current (I <sub>OK</sub> )		Input Ris
$V_{OUT} < -0.5V$	–20 mA	$V_{CC} =$
$V_{OUT} > V_{CC} + 0.5V$	+20 mA	Thermal
Output Voltage (V <sub>OUT</sub> )	–0.5V to V <sub>CC</sub> +0.5V	SOT23
DC Output Source or Sink		SC70-
Current (I <sub>OUT</sub> )	±12.5 mA	
DC V <sub>CC</sub> or Ground Current per		
Supply Pin (I <sub>CC</sub> or I <sub>GND</sub> )	±25 mA	
Storage Temperature (T <sub>STG</sub> )	$-65^{\circ}C$ to $+150^{\circ}C$	
Junction Temperature (T <sub>J</sub> )	150°C	Note 1: Abs
DC $V_{CC}$ or Ground Current per		age to the d without exce
(Soldering, 10 seconds)	260°C	power supp does not rec
Power Dissipation (P <sub>D</sub> ) @ +85°C		tions.
SOT23-5	200 mW	Note 2: Unu
SC70-5	150 mW	

## Recommended Operating

ditions (Note 2) Voltage 4.5V-5.5V oltage (V<sub>IN</sub>)  $0V-V_{CC}$  $0V-V_{CC}$ Voltage (V<sub>OUT</sub>)  $-40^\circ C$  to  $+85^\circ C$ ng Temperature (T<sub>A</sub>) ise and Fall Time  $(t_r, t_f)$ 5.0V 0–500 ns Resistance ( $\theta_{JA}$ ) 300°C/W 23-5 -5 425°C/W

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation of circuits outside the databook specifications.

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

## **DC Electrical Characteristics**

Symbol	Parameter	V <sub>cc</sub>	$V_{CC}$ $T_A = +25^{\circ}C$			$T_A=-40^\circ C$ to $+85^\circ C$		Units	Conditions	
Gymbol		(V)	Min	Тур	Max	Min	Max	onita	Contaitions	
V <sub>IH</sub>	HIGH Level Input Voltage	4.5-5.5	2.0			2.0		V		
V <sub>IL</sub>	LOW Level Input Voltage	4.5-5.5			0.8		0.8	V		
V <sub>OH</sub>	HIGH Level Output Voltage	4.5	4.4	4.5		4.4		V	$I_{OH}=-20~\mu A,~V_{IN}=V_{IL},$	
		4.5	4.18	4.35		4.13		V	$I_{OH} = -2 \text{ mA}$	
V <sub>OL</sub>	LOW Level Output Voltage	4.5		0	0.1		0.1	V	$I_{OL}=20~\mu A,~V_{IN}=V_{IH},$	
		4.5		0.10	0.26		0.33	V	$I_{OL} = 2 \text{ mA}$	
I <sub>IN</sub>	Input Leakage Current	5.5			±0.1		±1.0	μΑ	$0 \leq V_{IN} \leq 5.5 V$	
I <sub>CC</sub>	Quiescent Supply Current	5.5			1.0		10.0	μΑ	$V_{IN} = V_{CC}$ or GND	
I <sub>CCT</sub>	I <sub>CC</sub> per Input	5.5			2.0		2.9	mA	Input $V_{IN} = 0.5V$ or 2.4V	

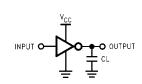
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Symbol	Parameter	V <sub>cc</sub>	T <sub>A</sub> = +25°C			$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	Figure
Symbol	Faldilletei	(V)	Min	Тур	Max	Min	Max	Units	Conditions	Number
t <sub>PLH</sub> ,	Propagation Delay	5.0		3.5	12			ns	C <sub>L</sub> = 15 pF	Figures
t <sub>PHL</sub>		5.0		6.0	17					
		4.5		6.2	16		20			
		4.0		11.4	27		31	-	C <sub>1</sub> = 50 pF	1, 3
		5.5		4.3	14		18	ns	C <sub>L</sub> = 50 μr	
		5.5		11.1	26		30			
t <sub>TLH</sub> ,	Output Transition Time	5.0		4	10			ns	$C_L = 15 \text{ pF}$	
t <sub>THL</sub>		4.5		11	25		31		$C_1 = 50  pF$	Figures 1, 3
		5.5		10	21		26	ns	0L – 20 hL	., 0
CIN	Input Capacitance	Open		2	10			pF		
CPD	Power Dissipation Capacitance	5.0		6				pF	(Note 3)	Figure 2

Note 3:  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I<sub>CCD</sub>) at no output loading and operating at 50% duty cycle. (See Figure 2.)  $C_{PD}$  is related to I<sub>CCD</sub> dynamic operating current by the expression:  $I_{CCD} = (C_{PD}) (V_{CC}) (f_{|N}) + (I_{CCstatic}).$ 

### AC Loading and Waveforms

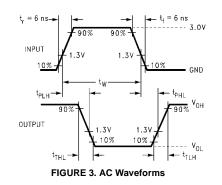


 $C_L$  includes load and stray capacitance Input PRR = 1.0 MHz,  $t_w$  = 500 ns

FIGURE 1. AC Test Circuit



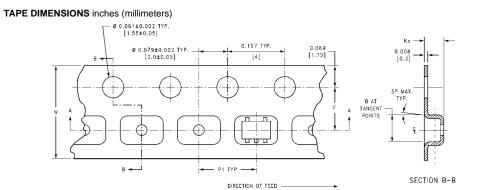
Input = AC Waveform; PRR = Variable; Duty Cycle = 50% FIGURE 2. I<sub>CCD</sub> Test Circuit

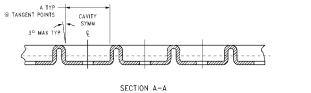




# Tape and Reel Specification TAPE FORMAT for SC70 and SOT23

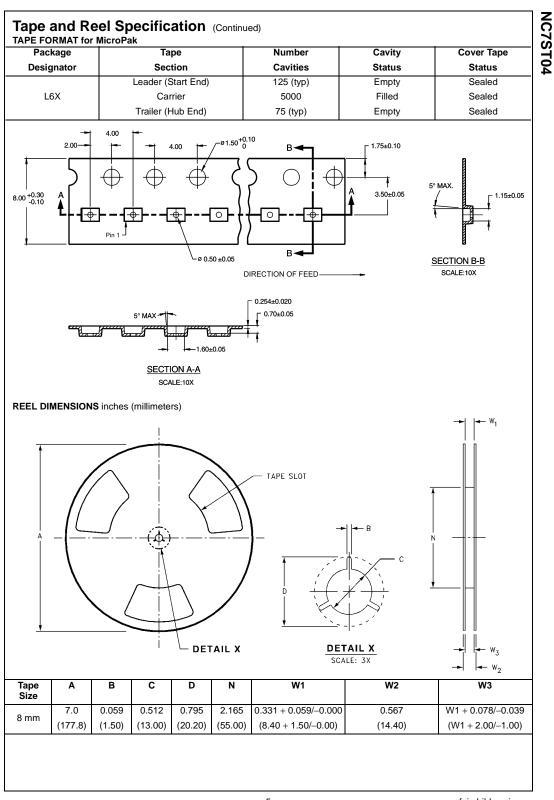
Package	Таре	Number	Cavity	Cover Tape
Designator	Section	Cavities	Status	Status
	Leader (Start End)	125 (typ)	Empty	Sealed
M5X, P5X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

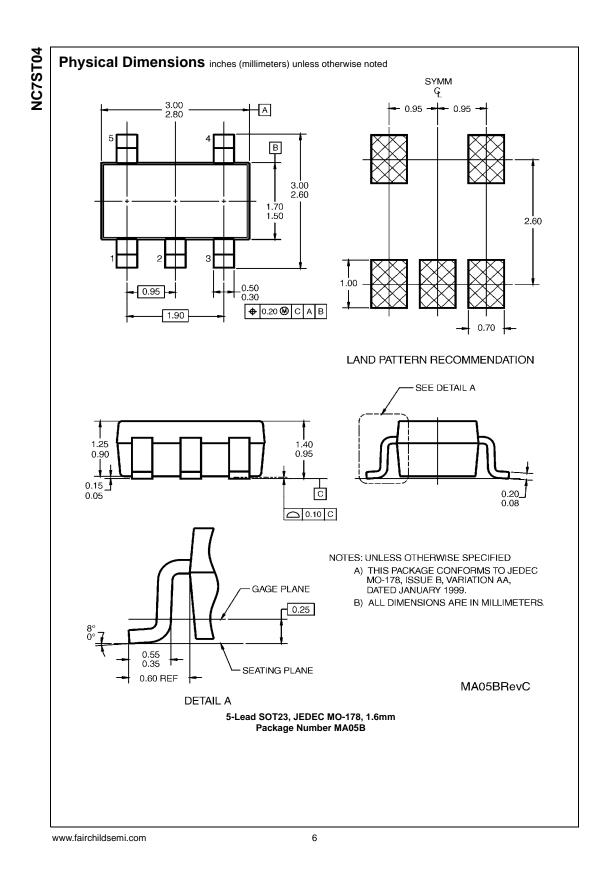


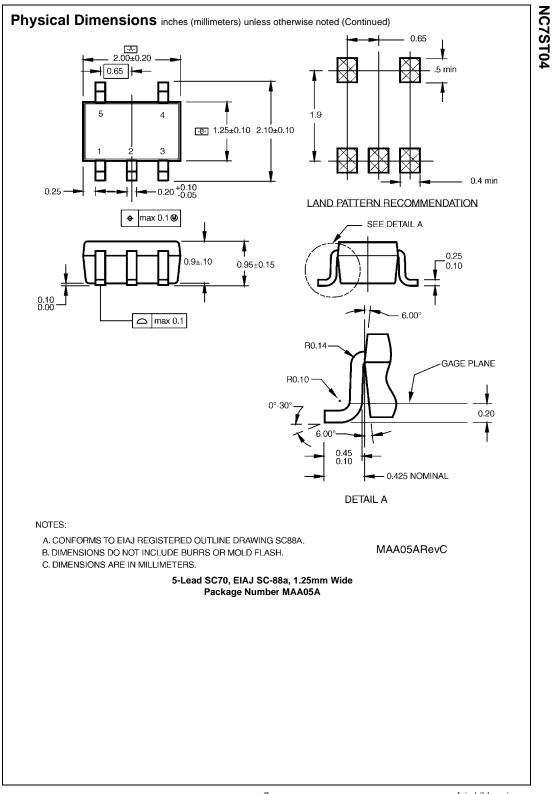




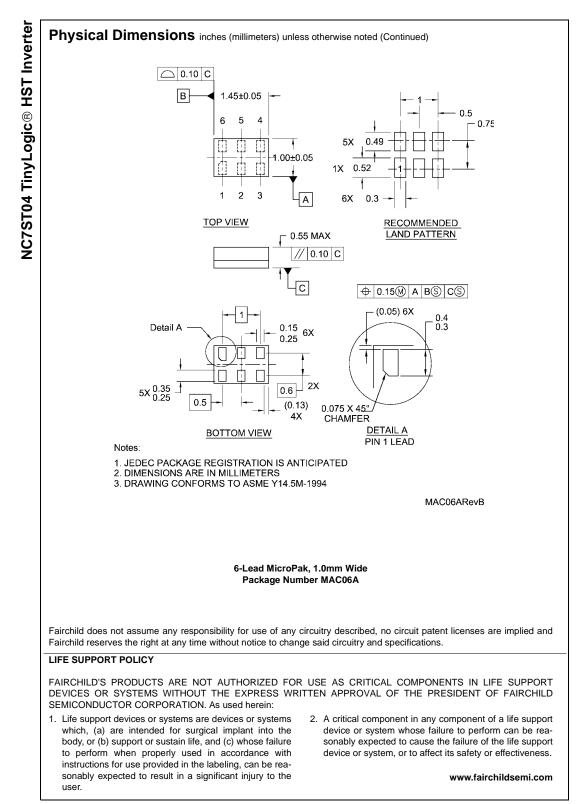
	BEND RADIUS NOT TO SCALE								
Package	Tape Size	DIM A	DIM B	DIM F	DIM K <sub>o</sub>	DIM P1	DIM W		
SC70-5	9 mm	0.093	0.096	$0.138\pm0.004$	$0.053\pm0.004$	0.157	$0.315 \pm 0.004$		
	8 mm	(2.35)	(2.45)	$(3.5\pm0.10)$	$(1.35 \pm 0.10)$	(4)	$(8\pm0.1)$		
SOT23-5	0.000	0.130	0.130	$0.138\pm0.002$	$0.055\pm0.004$	0.157	$0.315 \pm 0.012$		
	8 mm	(3.3)	(3.3)	$(3.5\pm0.05)$	$(1.4 \pm 0.11)$	(4)	(8 ± 0.3)		







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